

Crystal Clock Oscillator

■ NZ2016SH Data Sheet Standard Type

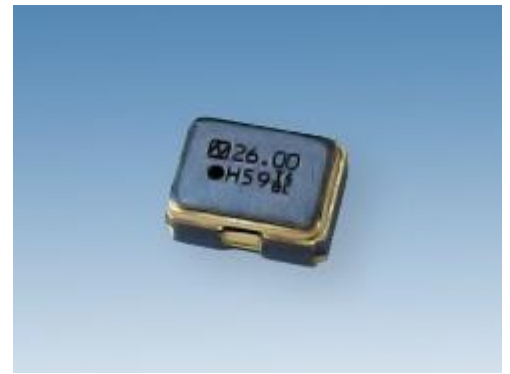
Application

For Automotive navigation system, Automotive audio equipment and Camera

For Smartphone, Tablet computers, Notebook PC, PC card, etc.

For Audio equipment and Wireless module

For Communication equipment for SDH/SONET, WiMAX, LTE, etc. and Base station



RoHS Compliant
Directive 2011/65/EU
Directive (EU) 2015/863

Pb free

AEC
Q100/Q200

Features

- Supports a wide temperature range from - 40 to +125 °C.
- Ultra compact and light. Dimensions : 2.0 x 1.6 x 0.7 mm, weight : 0.01 g.
- This crystal clock oscillator can support low frequencies (from 1.5 MHz) not easily achieved with crystal units of the same size.
- Low phase jitter (Typ. 100 fs (Frequency Offset : 12 kHz to 20 MHz)@80 MHz, 3.3 V)
- Taped units enable automatic mounting IR Reflow (lead free) is possible.
- Lead-free.
- Conforms to AEC-Q100/Q200.

1. Item : Crystal Clock Oscillator
 2. Type : NZ2016SH
 3. Nominal Frequency : 1.5 to 80 MHz
 4. NDK Spec. No. : See Table1

5. Maximum Ratings

	Item	Ratings			Notes
		min	max	Units	
1	Supply Voltage	-0.3	+4.0	V	
2	Input Voltage	-0.3	$V_{CC} + 0.3$	V	
3	Output Current	-20	+20	mA	
4	Storage Temperature Range	-55	+125	°C	

6. Electrical Specifications

	Parameters	SYM	Electrical Spec.				Notes
			min	typ	max	Units	
1	Nominal Frequency	f_{nom}	1.5		80	MHz	
2	Supply Voltage	V_{CC}	+1.8 to +3.3			V	
3	Current Consumption (Operating)	I_{CC}	See Table.2			mA	at 25 °C
4	Current Consumption (Stand-by)	I_{ST}			20	μA	at 25 °C
5	Output Level	-	CMOS				
6	Load Capacitance	C_L			15	pF	
7	Operating Temperature Range	T_{opr}	[-10 to +60] to [-40 to +125]			°C	Table.1
8	Overall Frequency Tolerance	$\Delta f/f_{nom}$	± 20 to ± 100			ppm	Table.1 *1
9	Output Voltage	V_{OL}			$0.1 V_{CC}$	V	
		V_{OH}	$0.9 V_{CC}$			V	
10	Rise Time(t_r), Fall Time(t_f)	t_r/t_f			5	ns	+2.5 V to +3.3 V 0.1 V_{CC} to 0.9 V_{CC}
					6	ns	+1.8 V 0.1 V_{CC} to 0.9 V_{CC}
11	Symmetry	SYM	45		55	%	at 1/2 V_{CC}
12	Start-up Time	t_{su}			4	ms	
13	Output Wave Form	-	Square wave				
14	Stand-by Function	#1 PAD input				# 3 PAD output	
		H level (0.7 V_{CC} to V_{CC}) or open				Operating	
		L level (0.3 V_{CC} max)				High impedance	

*1 Inclusive of Freq. tolerance (at 25 °C), frequency/temperature characteristics, frequency/voltage coefficient.

Table.1 NDK Spec. No. List

Overall Frequency Tolerance	Operating Temperature Range (°C)	Supply Voltage (V)			
		+1.8±0.18	+2.5±0.25	+3.0±0.3	+3.3±0.33
$\pm 100 \times 10^{-6}$	-40 to +125	NSC5019A	NSC5019B	NSC5019C	NSC5019D
$\pm 50 \times 10^{-6}$	-40 to +105	NSC5021A	NSC5021B	NSC5021C	NSC5021D
$\pm 50 \times 10^{-6}$	-40 to +85	NSC5022A	NSC5022B	NSC5022C	NSC5022D
$\pm 30 \times 10^{-6}$	-10 to +70	NSC5024A	NSC5024B	NSC5024C	NSC5024D
$\pm 20 \times 10^{-6}$	-10 to +60	NSC5025A	NSC5025B	NSC5025C	NSC5025D

Table.2 Current Consumption (Operating)

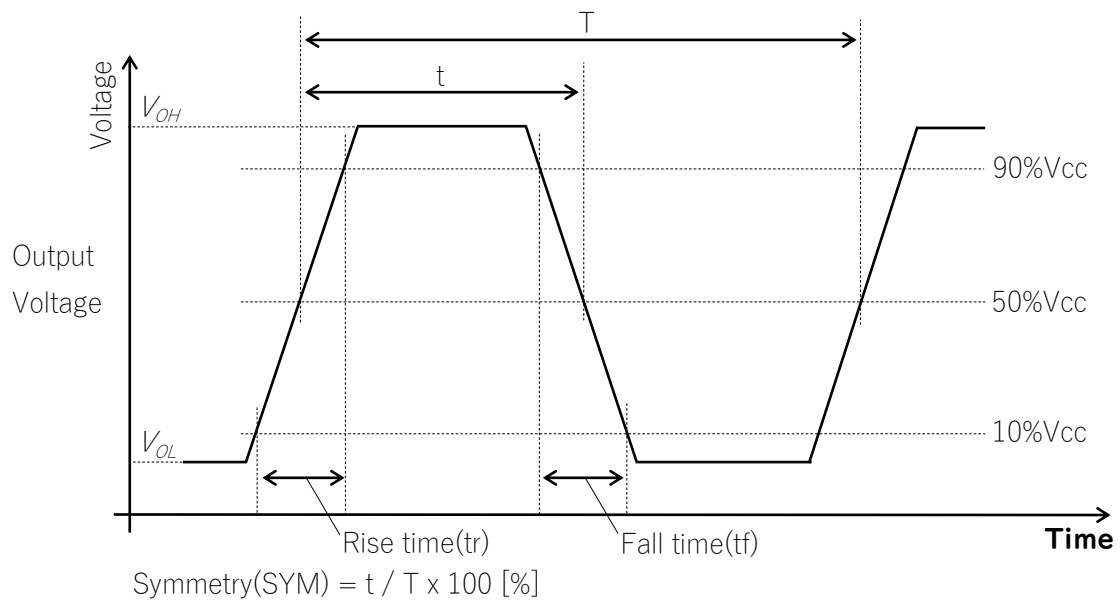
Nominal Frequency [MHz]	Current Consumption (mA)							
	$1.5 \leq F < 10$	$10 \leq F < 20$	$20 \leq F < 30$	$30 \leq F < 40$	$40 \leq F < 50$	$50 \leq F < 60$	$60 \leq F < 70$	$70 \leq F \leq 80$
1.8 V	2.5 MAX	3.5 MAX	4.0 MAX	4.5 MAX	5.0 MAX	5.5 MAX	6.0 MAX	6.5 MAX
2.5 V	3.0 MAX	4.0 MAX	4.5 MAX	5.0 MAX	5.5 MAX	6.0 MAX	6.5 MAX	7.5 MAX
3.0 V	3.5 MAX	4.5 MAX	5.0 MAX	5.5 MAX	6.0 MAX	6.5 MAX	7.5 MAX	8.5 MAX
3.3 V	3.5 MAX	4.5 MAX	5.0 MAX	5.5 MAX	6.0 MAX	7.0 MAX	8.0 MAX	9.0 MAX

Table.3 Supported Frequency List

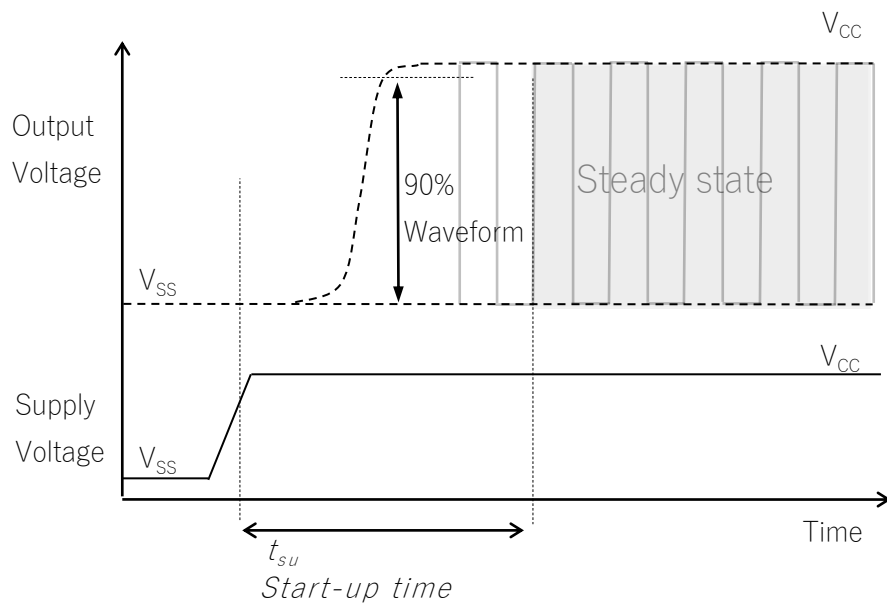
Nominal Frequency [MHz]						
12MHz	31.5MHz	60MHz				
13.33MHz	33.33MHz	63.75MHz				
18.432MHz	42MHz	64MHz				
24MHz	50MHz	74.25MHz				
24.576MHz	74.25MHz					
25MHz	MHz					
26MHz	40MHz					
27MHz	48MHz					
30MHz	50MHz					

Frequencies not listed in the list are also available, so please contact us if you have any request.

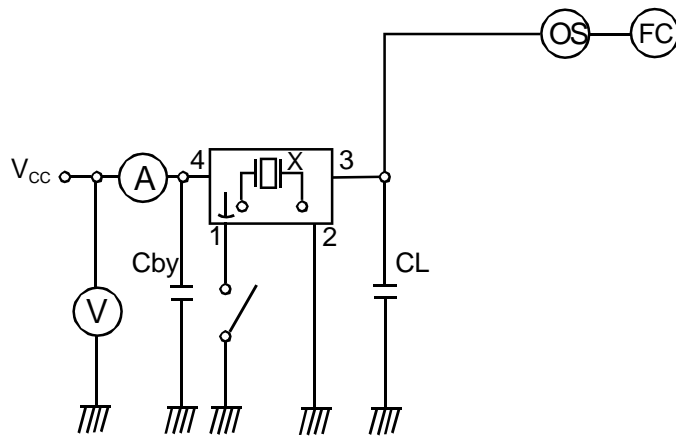
Output Voltage



Start-up Time



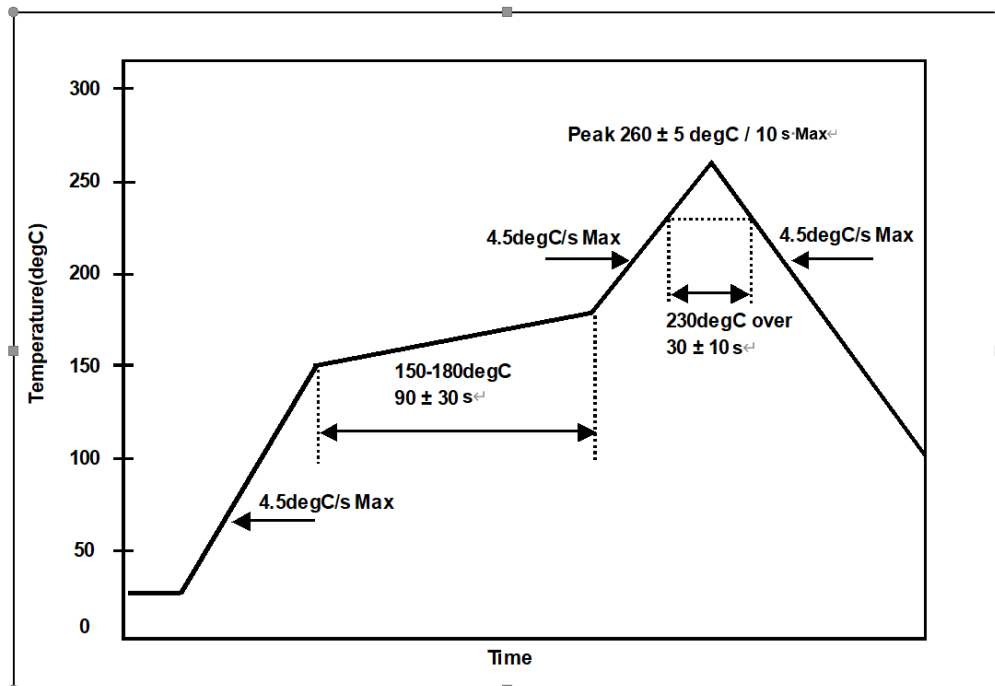
Measuring circuits



CL ; 15pF MAX including input capacity of oscilloscope
 Cby ; Bypass capacitor (0.01uF)

7. Prohibited items

Example For Soldering Conditions (The below graph corresponds to Pb free solder)



Be sure to use the product under the following conditions. Otherwise, the characteristics deterioration or destruction of the product may result.

(1) Reflow soldering heat resistance

Peak temperature: 265 °C, 10 s

Heating: 230 °C or higher, 40 s

Preheating: 150 °C to 180 °C, 120 s

Reflow passage times: 3 times

(2) Manual soldering heat resistance

Pressing a soldering iron of 350 °C on the terminal electrode for 3 s.

8. Electrostatic Discharge

MM: 200 V

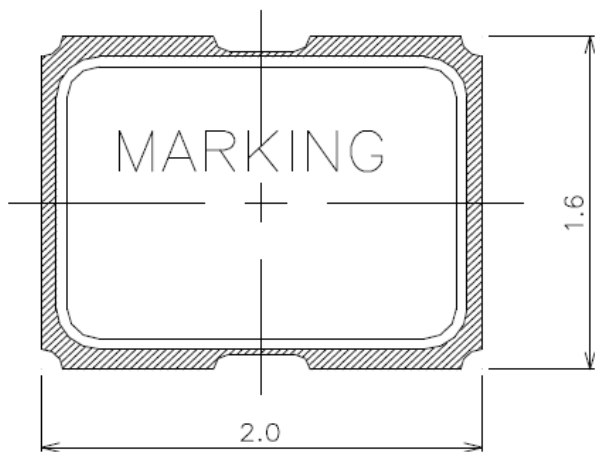
HBM: 2000 V

CDM: 500 V

Dimension of External

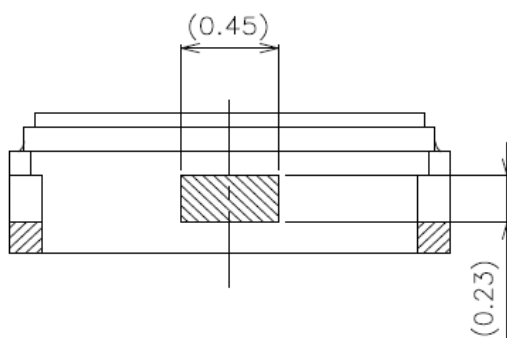
Unit : mm

Tolerance : ± 0.1 mm



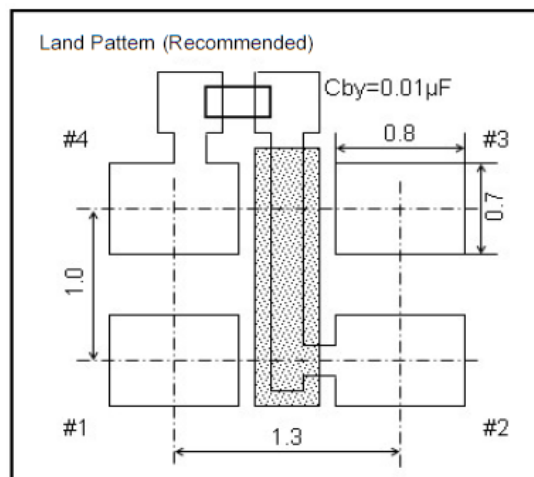
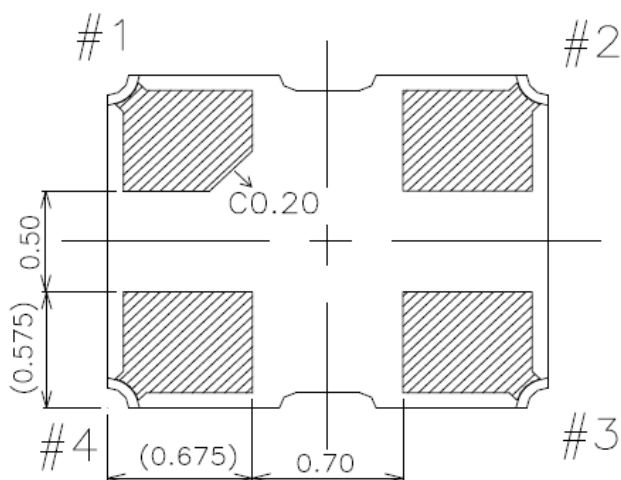
Terminal land connections

#1	STAND-BY
#2	GND
#3	OUTOUT
#4	Vcc



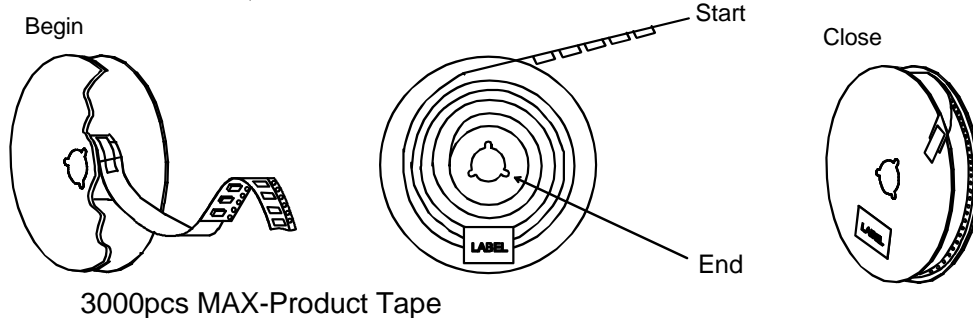
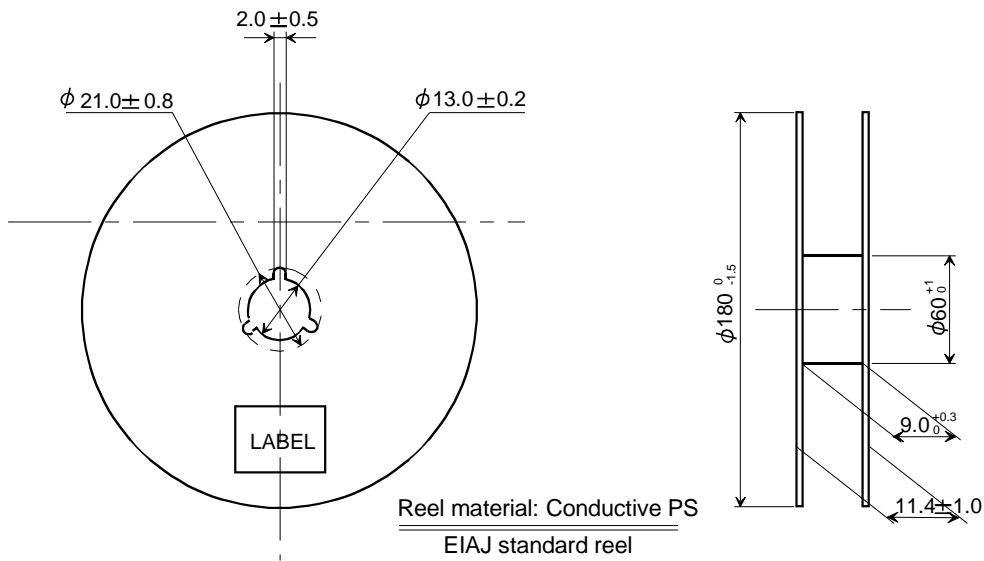
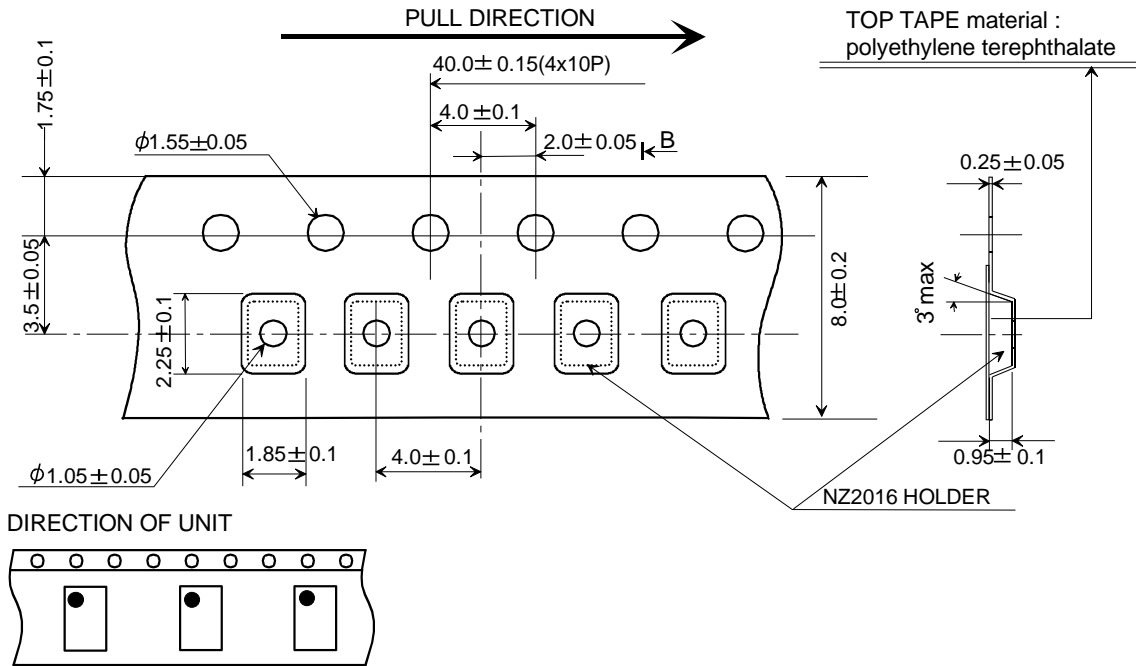
推奨ランドパターン図

Land pattern (Recommended)

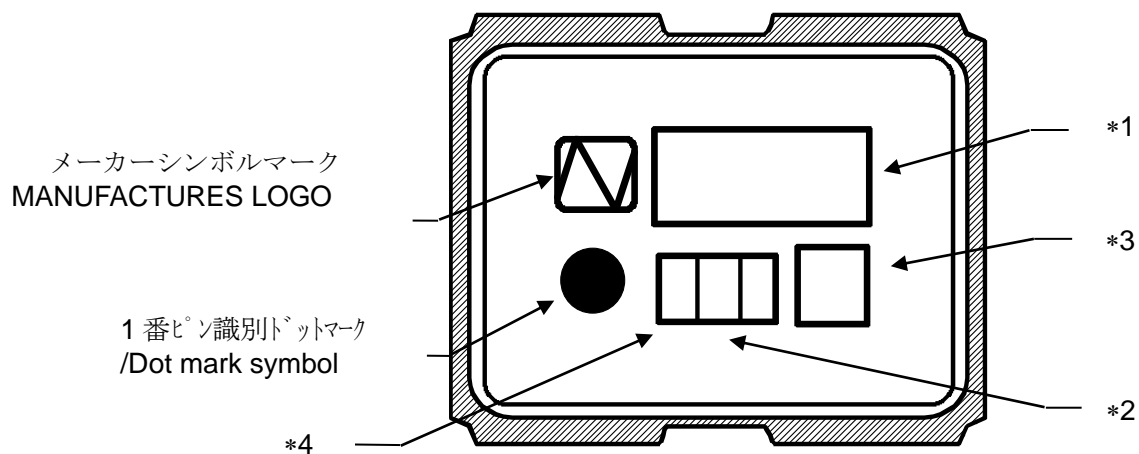


■ Taping and Reel Spec.

Unit : mm



■ Marking



※1 周波数[FREQUENCY]

※2 ロット記号(2桁)[Lot Code(Digits are two)]

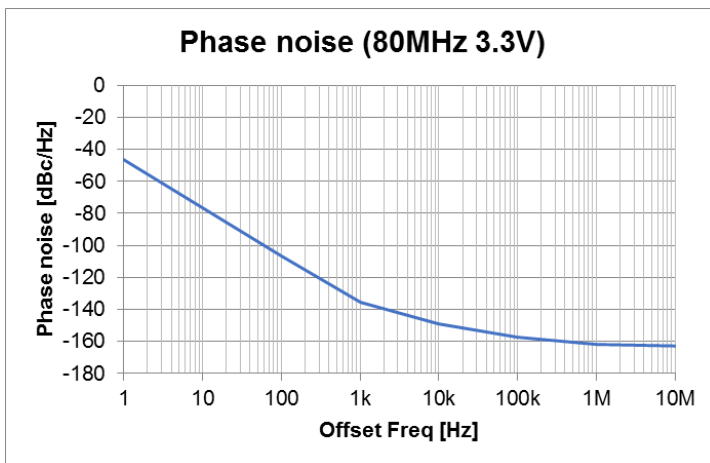
※3 トレースコード[Trace code]

※4 形名識別記号[Model Symbol]

NZ2016SH → H

■ Data

- Phase jitter



- Phase jitter : Typ. 100 fs (Frequency Offset: 12 kHz to 20 MHz) @80 MHz, 3.3 V

Instruction Notice

1 Noise

When using this product, please insert a bypass capacitor between the power supply and GND.
(Closer to the product terminal is desirable.)

The bypass capacitor values shown in our specifications and drawings are for reference only.
(They are not guaranteed values.)

In actual use, please select the appropriate bypass capacitor value for your circuit.

NDK shall not be liable for any and all events resulting from or in connection with the use of this product in a manner that does not comply with the above instruction.

2 Resistance to dropping

The NZ2016S series is designed to be impactproof so that no damage occurs when dropped a height (75 cm) three times. However, if dropped from a desk etc., it is advisable to check their performance or contact us to check it.

3 Electrostatic protection

The NZ2016S series employ C-MOS ICs for the active element. Please use them in static-free environments.

4 Cleaning

Basically, the NZ2016S series are applicable for ultrasonic wave cleaning. However, in some case, during ultrasonic wave cleanings, internal design may get damage. Please check condition carefully beforehand.

5 Other

The NZ2016S series are C-MOS applied products. And careful handling (same as with C-MOS IC) are needed to avoid electrostatic problems.

Incorrect PAD connection is cause of trouble. Please make sure to connect correctly as below.

#2 terminal → GND

#4 terminal → V_{CC}

Notes On Use

- 1 Even if the appearance color etc. of the product differs by purchasing the component parts by more than two companies, there is no influence on the characteristics and reliability.
- 2 IN THE CASE OF THE FOLLOWING ITEMS, WE ARE NOT RESPONSIBLE FOR WARRANTY / COMPENSATION.
 - (1) WHEN PRODUCTS OF THIS SPECIFICATION ARE USED FOR EQUIPMENT RELATED TO HUMAN LIFE OR PROPERTY, IT IS THE RESPONSIBILITY OF THE CUSTOMER TO CONFIRM THE INFLUENCE ON THIS PRODUCT AND EQUIPMENT TO BE USED BEFOREHAND, CONDUCT NECESSARY SAFETY DESIGN (INCLUDING REDUNDANT DESIGN, MALFUNCTION PREVENTION DESIGN, etc.), PLEASE USE IT AFTER SECURING SUFFICIENT SAFETY OF EQUIPMENT.
 - 1.SAFETY-RELATED EQUIPMENT SUCH AS AUTOMOBILES, TRAINS, SHIPS, etc., OR EQUIPMENT DIRECTLY INVOLVED IN OPERATION
 - 2.AIRCRAFT EQUIPMENT
 - 3.SPACE EQUIPMENT
 - 4.MEDICAL EQUIPMENT
 - 5.MILITARY EQUIPMENT
 - 6.DISASTER PREVENTION / CRIME PREVENTION EQUIPMENT
 - 7.TRAFFIC LIGHT
 - 8.OTHER EQUIPMENT REQUIRING THE SAME PERFORMANCE AS THE ABOVE-MENTIONED EQUIPMENT
 - (2) IN CASES WHERE IT IS NOT INDICATED IN THE REQUESTED STANDARD AND IS USED UNDER CONDITIONS OF USE (INCLUDING CIRCUIT MARGIN etc.) THAT CAN NOT BE PREDICTED AT THE PRODUCTION STAGE.
 - (3) WHEN USING ULTRASONIC WELDING MACHINE.(THERE IS A POSSIBILITY THAT THE CHARACTERISTIC DEGRADATION IS CAUSED BY THE RESONANCE PHENOMENON OF THE PIEZOELECTRIC MATERIAL.(EXAMPLE;CRYSTAL PIECE))
WE WILL NOT TAKE ANY RESPONSIBILITY FOR THE INFLUENCE OF THE CUSTOMERS' PROCESS.
SO, PLEASE SUFFICIENTLY EVALUATE AT A SAMPLE STEP WHEN YOU USE ULTRASONIC WELDING MACHINE.

- (4) USING RESIN MOLD MAY AFFECT THE PRODUCT CHARACTERISTIC.
PLEASE MAKE SURE TO TELL OUR SALES CONTACT WHEN YOU USE RESIN MOLD. WE WILL PERFORM INDIVIDUAL CORRESPONDENCE ABOUT A DELIVERY SPECIFICATION AND A EVALUATION METHOD.
IN ADDITION, IF YOU USE RESIN MOLD WITHOUT CONTACTING US, AND CAUSES DAMAGES AGAINST A CUSTOMER OR A THIRD PARTY, WE WILL NOT BE LIABLE FOR THE DAMAGES AND OTHER RESPONSIBILITIES BECAUSE WE CONSIDER IT IS UNDER ELF-RESPONSIBILITY USING RESIN MOLD.
WE WILL NOT TAKE ANY RESPONSIBILITY FOR THE INFLUENCE OF THE CUSTOMERS' PROCESS. PLEASE EFFICIENTLY EVALUATE AT A SAMPLE STEP WHEN YOU USE RESIN MOLD.
- (5) WHEN PERFORMING IMPROPER HANDLING THAT EXCEEDS THE GUARANTEED RANGE.
- 3 This product can not be used for equipment related to the safety of automobiles or equipment directly involved in operation.(example: air bag, TPMS, engine control, steering control, brake control etc.)

Notes on storage

- 1 When storing the product in high temperature and high humidity condition for a long time, product characteristics (solderability etc.) and packaging condition may be deteriorated. Please store product at temperature + 5 °C to + 35 °C, humidity 85 % RH or less. The product is an electronic component, so please do not storage and use, under a dewing state.
- 2 The product storage deadline is 12 months after delivery in unopened state. Please use within storage deadline. If you exceed storage deadline, please check the product characteristics etc, please use.

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